### 502114333 11/01/2012

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Toshiyuki YOKOSUKA	07/04/2012
Minoru YAMAZAKI	07/05/2012
Hideyuki KAZUMI	07/05/2012
Kazutami TAGO	07/04/2012

#### **RECEIVING PARTY DATA**

Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION	
Street Address:	24-14, Nishi-Shimbashi 1-chome	
City:	Minato-ku, Tokyo	
State/Country:	JAPAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13580288

# **CORRESPONDENCE DATA**

**Fax Number**: 2026288844

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2026242500

Email: Galemousavi@crowell.com
Correspondent Name: Crowell & Moring LLP
Address Line 1: P.O. Box 14300

Address Line 4: Washington, DISTRICT OF COLUMBIA 20044-4300

ATTORNEY DOCKET NUMBER: 108004.64873US

NAME OF SUBMITTER: Michael H. Jacobs

Total Attachments: 1

source=64873US\_Assignment#page1.tif

PATENT REEL: 029225 FRAME: 0894 D \$40.00 135802

Attorney Docket Number: 108004.64873US

# **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTRON BEAM IRRADIATION METHOD AND SCANNING ELECTRON MICROSCOPE

\* PCT International Application Number PCT/JP2011/000706 filed on February 9, 2011

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S)	Date Signed
	(発明者フルネームサイン)	(署名日)
1)	Toshiyuki Yokosuka Toshiyuki Yokosuka	7/4/2012
2)		7/5/20/2
2)	Minoru Yamagaki Minoru YAMAZAMI	7/1-1
3)	Hideyuki KAZUMI	1/5/2012
4)	Hideyuki KAZUMI Kazutami Tago Kazutami (AGO	7/5/2012
5)	Kazutami (yAGO	
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 029225 FRAME: 0895

**RECORDED: 11/01/2012**